

**Major Terms of HKMC's HKD and CNH Bond Issue**

<b>Issuer:</b>	The Hong Kong Mortgage Corporation Limited	
<b>Expected Issue Rating:</b>	AA+ (S&P) / Aa3 (Moody's)	
<b>Issue Date:</b>	9 February 2021	
	<b>HKD Bond Issue</b>	<b>CNH Bond Issue</b>
<b>Issue Size:</b>	HK\$7 billion	CNH2.5 billion
<b>Maturity Date:</b>	9 February 2023	9 February 2024
<b>Tenor:</b>	2 years	3 years
<b>Coupon:</b>	0.5% per annum	2.7% per annum
<b>Status:</b>	Senior and unsecured	
<b>Listing:</b>	The Stock Exchange of Hong Kong Limited	
<b>Joint Global Coordinators, Joint Lead Managers and Joint Bookrunners:</b>	Crédit Agricole Corporate and Investment Bank, The Hongkong and Shanghai Banking Corporation Limited and Standard Chartered Bank	
<b>Joint Lead Managers and Joint Lead Bookrunners:</b>	Australia and New Zealand Banking Group Limited, Bank of China (Hong Kong) Limited and Mizuho Securities Asia Limited	